

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Deyuan Xiao</td> <td>04/23/2010</td> </tr> <tr> <td>Xi Wang</td> <td>04/23/2010</td> </tr> <tr> <td>Miao Zhang</td> <td>04/23/2010</td> </tr> <tr> <td>Jing Chen</td> <td>04/23/2010</td> </tr> <tr> <td>Zhongying Xue</td> <td>04/23/2010</td> </tr> </tbody> </table>		Name	Execution Date	Deyuan Xiao	04/23/2010	Xi Wang	04/23/2010	Miao Zhang	04/23/2010	Jing Chen	04/23/2010	Zhongying Xue	04/23/2010
Name	Execution Date												
Deyuan Xiao	04/23/2010												
Xi Wang	04/23/2010												
Miao Zhang	04/23/2010												
Jing Chen	04/23/2010												
Zhongying Xue	04/23/2010												
RECEIVING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Shanghai Institute of Microsystem and Information Technology Chinese Academy of Sciences</td> </tr> <tr> <td>Street Address:</td> <td>No. 865 Changning Road, Changning District</td> </tr> <tr> <td>City:</td> <td>Shanghai</td> </tr> <tr> <td>State/Country:</td> <td>CHINA</td> </tr> <tr> <td>Postal Code:</td> <td>200056</td> </tr> </table>		Name:	Shanghai Institute of Microsystem and Information Technology Chinese Academy of Sciences	Street Address:	No. 865 Changning Road, Changning District	City:	Shanghai	State/Country:	CHINA	Postal Code:	200056		
Name:	Shanghai Institute of Microsystem and Information Technology Chinese Academy of Sciences												
Street Address:	No. 865 Changning Road, Changning District												
City:	Shanghai												
State/Country:	CHINA												
Postal Code:	200056												
PROPERTY NUMBERS Total: 1													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12810648</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12810648								
Property Type	Number												
Application Number:	12810648												
CORRESPONDENCE DATA													
<p>Fax Number: (650)963-1565</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 2096762219</p> <p>Email: tianhuagu@comcast.net</p> <p>Correspondent Name: Tianhua Gu</p> <p>Address Line 1: 7285 W. Eagle Court</p> <p>Address Line 4: Winton, CALIFORNIA 95388</p>													
ATTORNEY DOCKET NUMBER:	GUH-112US												
NAME OF SUBMITTER:	Tianhua Gu												

OP \$40.00 12810648

501216590

PATENT
REEL: 024598 FRAME: 0204

Total Attachments: 2

source=GUH112ASSIGN#page1.tif

source=GUH112ASSIGN#page2.tif

ASSIGNMENT

WHEREAS, I/WE:

XIAO DEYUAN, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

WANG XI, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

ZHANG MIAO, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

CHEN JING, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

XUE ZHONGYING, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

have invented certain new and useful improvements in the following:

HYBRID MATERIAL ACCUMULATION MODE GAA CMOSFET
(PCT application number:PCT/CN2010/070645)

for which a United States patent application therefor has been executed on 4/23/10,
U.S. Patent Application No.: 12810648;

WHEREAS,

**SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION
TECHNOLOGY CHINESE ACADEMY OF SCIENCES**

(hereinafter referred to as the Assignee), a body having a place of business at
No.865, Changning Road, Changning District, Shanghai-200056, China and corporate
powers under the laws of **China**, desires to acquire the entire right, title and interest in
said application and invention, and to any United States and foreign patents to be
obtained therefor.

NOW THEREFORE, for a valuable consideration, receipt whereof is hereby
acknowledged, I/we, the above named, hereby sell, assign, and transfer to Assignee, its
successors and assigns, the entire right, title and interest in said application and

inventions therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said application, I/we hereby agree that Assignee may apply for foreign Letters Patent on said inventions, and I/we hereby agree to timely execute all papers necessary in connection with said United States and foreign Letters Patent applications when called upon to do so by Assignee.

I/we hereby covenant that I/we have the full and lawful right to convey the entire right, title, and interest herein assigned, and that I/we have not entered and will not enter into any agreement in conflict herewith.

I/we hereby request the Commissioner for Patents to issue any Letters Patent granted upon the inventions set forth in said application to Assignee, its successors and assigns.

Date: Apr. 19, 2010 Dequan Xiao
XIAO DEYUAN

Date: Apr. 24, 2010 Xi Wang
WANG XI

Date: Apr. 19, 2010 Miao Zhang
ZHANG MIAO

Date: Apr. 19, 2010 Jing Chen
CHEN JING

Date: Apr. 19, 2010 Zhongying Xue
XUE ZHONGYING